

RX63N, RX631 Group

Quick Design Guide

R01AN1657EU0111 Rev.1.11 Feb 3, 2014

Introduction

This document answers common questions and points out subtleties of the MCU that might be missed unless the hardware manual was extensively reviewed. The document is not intended to be a replacement for the hardware manual; it is intended to supplement the manual by highlighting some key items most engineers will need to start their own design. It also discusses some design decisions from an application point of view.

Target Device

RX63N Group

RX631 Group

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1. Power Supplies

The RX family has digital power supplies and analog power supplies. The power supplies use the following pins.

Digital Power Supplies

Symbol	Name	Description
VCC	Power supply	3.3V power supply. Connect to the system power supply. Connect this pin to VSS via a 0.1 uF capacitor placed close to the VCC pin.
VSS	Ground	Ground
VCL	Power supply	Connect this pin to VSS via a 0.1uF capacitor close to the VCL pin.
VBATT	Backup power	Backup power pin. Supplies power to RTC and sub-clock oscillator in the absence of VCC. When VBATT pin is not used, connect to VCC.
VCC_USB	USB power supply	USB power supply pin. Connect this pin to VCC. If USB is not used, it is safe to omit the 10uF cap on VCC_USB.
VCC_VSS	USB ground	USB ground pin. Connect this pin to VSS.

Analog Power Supplies

Symbol	Name	Description
AVCC0	12-bit ADC power supply	Analog voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit ADC is not used.
AVSS0	12-bit ADC ground	Analog ground for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit ADC is not used.
VREFH0	12-bit ADC high reference voltage	Reference power supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit ADC is not used.
VREFL0	12-bit ADC low reference voltage	Analog reference ground pin for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit ADC is not used.
VREFH	10-bit ADC & DAC analog supply	Reference voltage input pin for the 10-bit A/D converter and D/A converter. This is used as the analog power supply for these modules. Connect this pin to VCC if neither the 10-bit ADC nor the DAC is used.
VREFL	10-bit ADC & DAC analog ground	Reference ground pin for the 10-bit A/D converter and D/A converter. This is used as the analog ground for the respective modules. Connect this pin to VSS.



1.1 References

Further information regarding the power supply for the RX can be found in the following documents:

R01UH0041EJ0160 RX63N Group, RX631 Group User's Manual: Hardware

Chapter 1, "Overview", lists power pins in each package with recommended bypass capacitors.

Chapter 6, "Resets", discusses the Power-on reset and how to differentiate this from other reset sources.

Chapter 8, "**Voltage Detection Circuit**", provides details on the Low-Voltage Detection Circuit that can be used to monitor the power supply. Chapter 7, "**Option-Setting Memory**" additionally describes how to enable Low-Voltage Detection 0 Circuit automatically at startup.

Chapter 12, "Battery Backup Function", shows how to provide battery backup to the RTC and sub-clock oscillator.

If you plan to use the on-chip Analog to Digital Converters or the Digital to Analog Converter (DAC), see chapter 41, "**12-Bit A/D Converter (S12ADa)**", chapter 42, "**10-Bit A/D Converter (ADb**)", and Chapter 43, "**D/A Converter (DAa)**" for details on how to provide filtered power supplies for these peripherals.

Chapter	Name	Description
1	Overview	Lists power pins in each package with notes on termination and bypassing.
6	Resets	Discusses the Power-on Reset and how to differentiate this from other reset sources.
8	Voltage Detection Circuit	Provides details on the Low-Voltage Detection Circuit that can be used to monitor the power supply.
11	Low Power Consumption	Using low power modes may allow you to reduce the voltage of the power supply. See this chapter for details on how operating modes affect power supply requirements.
12	Battery Backup Function	Shows how to provide battery backup to the RTC and sub- clock oscillator
41	12-Bit A/D Converter	If you plan to use the on-chip A/D or D/A converters, these
42	10-Bit A/D Converter	chapters give details on how to provide filtered power
43	D/A Converter	supplies for these peripherals.

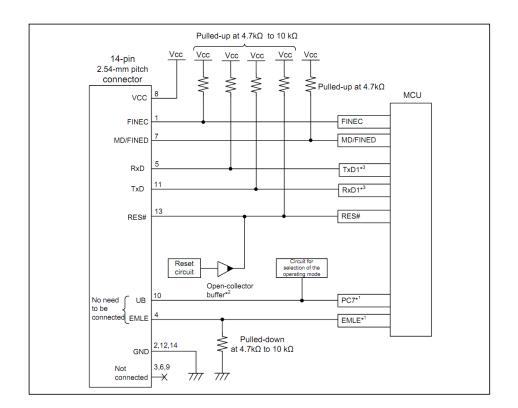


2. Emulator Support

Three debug interfaces are available for members of the RX63x group:

- **2-wire FINE interface** that supports full on-chip debugging. It does not provide external trace-output function, real-time RAM monitoring, or hot-plug in. Renesas emulators support a FINE connection through the standard 14-pin E1 interface.
- **14-pin E1 interface** that supports full on-chip debugging using JTAG communications. It does not provide external trace-output function. These connectors are general-purpose connectors with a pitch of 2.54mm.
- **38-pin E20 interface** that supports basic functions that employ JTAG and other communications, plus the external trace-output function for acquiring large amounts of trace data in real time. The fine-pitch MICTOR connector is as compact as the 14-pin connectors, but this connection reduces the number of dedicated MCU pins available for user's application.

Boundary scan is available on members of the RX63x group that are in larger package sizes: LGA145, LGA177, and BGA176. For full details on emulator support, refer to documents listed in chapter 15 - References.



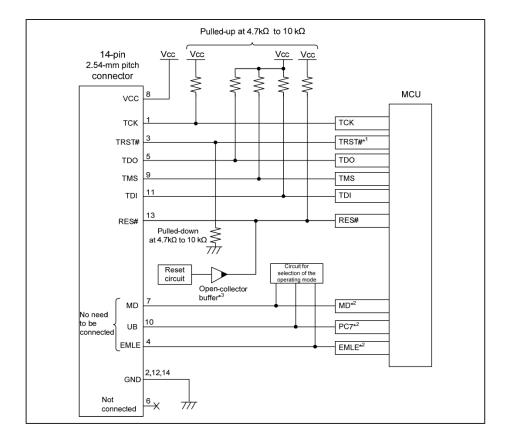
2.1 Fine 2-Wire Interface

Notes:

- 1. Pull down the EMLE signal with a 4.7k to 10k resistor. PC7 is used to select between serial boot mode and user/USB boot mode; connection to this pin is specific to your application.
- 2. The output of the reset circuit of the user system must be open collector.
- 3. RxD1 and TxD1 signals are not required for debugging, but may be connected to the 14-pin connector for optional use with the Renesas Flash Programmer tool. These pins ARE required to be connected for production programming.



2.2 E1 Emulator 14-Pin Interface

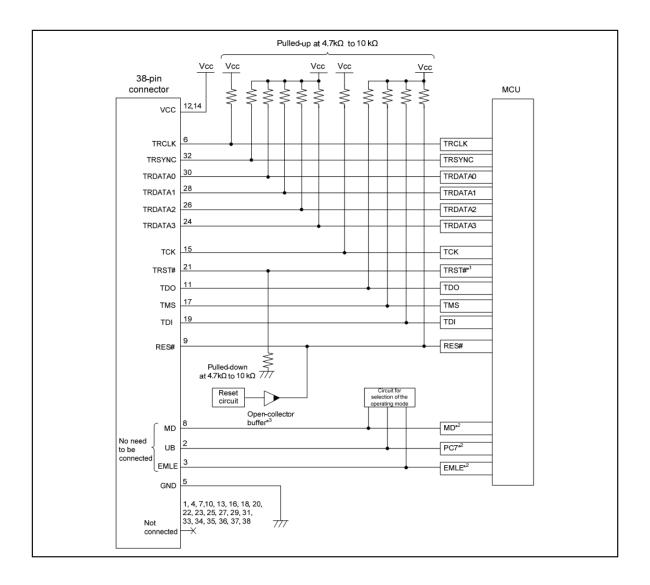


Notes:

- 1. A 4.7k to 10k resistor can be used to pull up the TRST# signal. Note, however, that hot plug-in will not be available if TRST# is pulled up.
- 2. For processing of MD, PC7, and EMLE, see section 3 MCU Operating Modes.
- 3. The output of the reset circuit of the user system must be open collector.



2.3 E20 Emulator 38-Pin Interface



Notes:

- 1. A 4.7k to 10k resistor can be used to pull up the TRST# signal. Note, however, that hot plug-in will not be available if TRST# is pulled up.
- 2. For processing of MD, PC7, and EMLE, see section 3 MCU Operating Modes.
- 3. The output of the reset circuit of the user system must be open collector.

2.4 Notes on Emulator Connections

The following notes should be taken into consideration when designing emulator connections:

- 1. RES# circuitry on the target must be open-collector. Pull up the RES# signal on the RX; do not put a cap on this signal as it will affect the operation of the power-on reset circuit.
- 2. Use 4.7K to 10K pull-ups on TCK, TDO, TMS, and TDI. Use a pull-down on TRST#.
- 3. Use pull-ups on trace connections: TRCLK, TRSYNC#, TRDATA0-3.
- 4. Connect MD, PC7, and EMLE to the debug connector to use flash programming. MD and PC7 should be pulled to levels appropriate to the application & boot modes; the emulator will override these when connected. Pull the EMLE pin low with a pull-down resistor; Renesas emulators will pull this signal high during debugging.



3. MCU Operating Modes

The RX63N and RX631 Group MCU's can enter one of three modes after reset: single-chip mode, serial boot mode, or User/USB boot mode. The boot mode is selected by the MD pin and, optionally, the state of the PC7 port pin:

Mode	MD	PC7	Execution starts at	Memory available for program/erasure
Single-chip mode	1	Don't care	Address located at 0xFFFF FFFC	User flash areaData flash area
Serial boot mode	0	0	Factory loaded serial bootloader	User flash areaData flash areaUser boot area
User/USB boot mode	0	1	Address located at 0xFF7F FFFC	User flash areaData flash area

User boot mode, along with the 16KB User Boot Mat flash area, provides the user with a convenient way to implement a custom bootloader. For more information on this refer to the "Simple Flash API for RX" application note (see Chapter 15 –References). The user boot area is preprogrammed at the factory with the Renesas USB bootloader. The user can replace the Renesas USB bootloader with a custom bootloader; see the chapter "ROM (Flash memory for Code Storage)" in the Hardware Manual for details.

The MCU can transition into 2 other operating modes after reset by modifying the ROME and EXBE bits in the System Control Register 0 (SYSCR0). Clearing the ROME bit disables the on-board flash ROM areas. Setting the EXBE bit enables the external memory bus. The table below shows the details of each mode.

Table 3 - Software Selectable Operating Modes

Mode	ROME	EXBE	On-Chip Rom	External Bus	
After reset	1	0	Enabled	Disabled	
On-chip ROM Enabled Extended Mode	1	1	Enabled	Enabled	
On-chip ROM Disabled Extended Mode	0	1	Disabled ^{*1}	Enabled	

Notes 1. After disabling the On-Chip ROM by clearing the ROME bit, it cannot be re-eanbled.

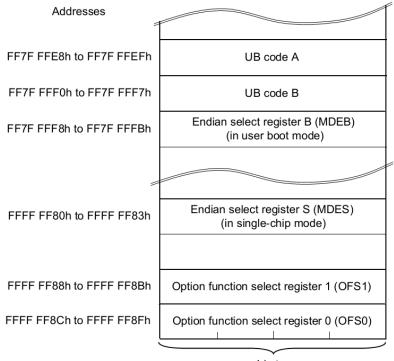


4. Option Setting Memory

A new feature on the RX63x is the Option Setting Memory. These are flash-based registers that are set when the device is programmed, and that govern the operation of the chip immediately after reset. The registers are detailed in Chapter 7 of the Hardware Manual: "Option Setting Memory".

The flash option registers occupy space in the normal memory map. Although the registers are located in a portion of the flash memory that was reserved on the RX62x, it is possible that some customers may have stored data in these locations inadvertently. The user must check to ensure that no unwanted data is written to these locations or else unexpected behavior of the chip may result. For instance, settings in the flash option registers can enable the Independent Watchdog Timer (IWDT) immediately after reset. If data stored in program ROM inadvertently overlaps the flash option register, it is possible to turn on the IWDT on without realizing it. This will cause the debugger to have communications problems with the board.

The image below shows the Option setting memory which consists of the option function select registers and 4 other registers. These registers are divided into two groups located in flash-memory and are read on boot-up to determine endianness, and also if peripherals like the Independent Watchdog Timer (IWDT), the High-speed On-chip Oscillator (HOCO) and the Low Voltage Detection circuit (LVD0) are operational or not at boot time.



4 bytes

Figure 1: Option Function Select registers

Enabling the HOCO via these registers means that the HOCO is powered up and will start stabilizing immediately after reset. This reduces the wait time when switching from the LOCO (the default clock source on startup) to the HOCO. If, however, power savings is a requirement, then the registers can be configured to leave the HOCO off on power-up. The OFS registers are also used to configure all the aspects of the IWDT operation.

4.1 Option Setting Memory Registers

Below is a summary of the Option Setting Memory registers. Make sure that they are configured properly before startup.

- OFS0 register
 - Independent Watchdog Timer (IWDT) auto start
 - o IWDT timeout, frequency, windowing, interrupt type, and low power mode behavior
 - Watchdog Timer (WDT) auto start
 - WDT timeout, frequency, windowing, and interrupt type
- OFS1 register
 - o LVD0 enable after reset



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• HOCO startup after reset

- MDES/MDEB registers
 - Big/little endian mode
- UB Codes: In order to use the User Boot mode with a customer bootloader, it is necessary to configure the UB codes. Refer to Section 7.3 in the hardware manual for details.

Below is an example on how to set the option setting memory register, MDES, which is at the address 0xFFFFF80. Note that unused/reserved bits are written to a '1' as instructed in the Hardware Manual; be sure to set unused/reserved bits per the hardware manual.

```
/* Allocate the name MDESreg to the address 0xFFFFFF80 */
#pragma address MDESreg = 0xFFFFF80
#ifdef __BIG
/* Set as Big Endian */
const unsigned long MDESreg = 0xFFFFFF8u
#else
/* Set as Little Endian */
const unsigned long MDESreg = 0xFFFFFFFu
#endif
```

Most sample projects and demo code from Renesas includes code to set the option registers.

5. Clock Circuits

The RX63N/RX631 group MCUs have five oscillators (see Table 4 - RX63X Oscillators). Four of these may be used as the source for the main system clock; the remaining oscillator is dedicated to the Independent Watchdog Timer. In a typical system, the main clock is driven with an external crystal or clock. This input is directed to the PLL where it is multiplied up to the 104-200 MHz input range required by the PLL, and then post-divided down into the final system clock speed which can have a maximum speed of 100 MHz.

Oscillator	Input source	Frequency	Primary uses	
Main clock	External crystal/resonator	4 MHz to 16 MHz	PLL input, main system clock, peripherals clocks, flash	
	-or-		clock, bus clock, SDRAM clock, IEBUS clock, USB	
	External clock	Up to 20 MHz	clock, CAN clock	
Sub-clock	External crystal/resonator	32 kHz	Real-time clock, system clock in low power modes	
High-speed on-chip (HOCO)	On-chip oscillator	50 MHz	Main system clock, peripheral clocks in low power modes	
Low-speed on-chip (LOCO)	On-chip oscillator	125 kHz	System clock at startup, in low power modes, & during main oscillator stop detection	
Independent Watchdog (IWDT)	On-chip oscillator	125 kHz	Independent watchdog timer clock	

Table 4 - RX63X Oscillators

5.1 Reset Conditions

After reset, RX63x MCU's begin running with the low-speed on-chip oscillator (LOCO) as their main clock source. The LOCO runs at 125 kHz which enables the part to start in a low-power state. Application code should switch to a higher speed clock source as soon as is practical. Particular care should be taken to make sure that a faster clock source is selected before the compiler startup code that initializes the C language runtime environment runs or else long startup times may result. At reset, the main oscillator and the PLL are off by default. The HOCO and IWDT may be on or off depending on the settings in the Option Setting Memory (see section 4).



5.2 Clock Frequency Requirements

The ICLK must always be greater than or equal to the BCLK. Minimum and maximum frequencies are shown in the table below.

Table 5.5 : Frequency Range for MCU Clocks

	ICLK	PCLKA	PCLKB	PCLKC	PCLKD
Maximum Frequency [MHz]	100	100	50	100	50
Minimum Frequency [MHz]	1	1	2		

^{1.} The ICLK and PCLKA frequencies must be the same and at least 12.5 MHz if the Ethernet controller is in use

^{2.} The PCLKB must run at a frequency of at least 24 MHz if the USB is in use.

	FCLK	BCLK	UCLK	CANCLK	IECLK
Maximum Frequency [MHz]	50	100	48	20	50
Minimum Frequency [MHz]	1	2	48	_	_

^{1.} The FCLK must run at a frequency of at least 4 MHz when writing or erasing ROM or data flash.

² While BLCK can be set to 100 MHz, the maximum frequency that can be output on the BCLK pin is 50 MHz. A 50 MHz clock can be output on the BCLK pin with a BCLK frequency of 100MHz by setting the BCLKDIV bit.

5.2.1 Requirements for USB Communications

The USB 2.0 Host/Function Module (USB) available on some members of the RX family requires a 48 MHz USB clock signal (UCLK). UCLK is generated internally by dividing the PLL by either 3 or 4. The divider used depends on the setting of the UCK bits in the SCKCR2 register. Additionally, the peripheral clock B (PCLKB) must be set to a minimum of 24 MHz when USB is enabled.

5.2.2 Requirements for Ethernet Controller

When the Ethernet controller (EtherC) and Ethernet DMA Controller (E-DMAC) are used, PCLKA (Ethernet) must be the same as ICLK, and both must be 12.5 MHz or greater.

5.2.3 Requirements for Programming and Erasing ROM or Data Flash

The FCLK must be at least 4MHz to perform programming and erasing on internal ROM and data flash.

5.2.4 Requirements for SDRAM Controller

When the SDCLK is used, BCLK cannot exceed 50 MHz.

5.3 Lowering CGC Power Consumption

The CGC area can account for 30%-40% of the power consumption of the chip. To aid in saving power, set the dividers for any unused clocks (i.e. BCLK) to the highest possible value whenever possible. Also, if not using a clock then make sure that it has been stopped by setting the appropriate register(s). The registers for controlling each clock source are shown in the table below.

Table 5.6 : Clock Source Configuration Registers

Oscillator	Register	Description
Main clock	MOSCCR	Starts/stops main clock oscillator
Sub-clock	SOSCCR	Starts/stops sub-clock oscillator
High append on this (HOCO)	HOCOCR	Starts/stops HOCO
High-speed on-chip (HOCO)	HOCOPCR	Turns power on/off for HOCO
Low-speed on-chip (LOCO)	LOCOCR	Starts/stops LOCO
Independent Watchdog (IWDT)	ILOCOCR	Starts/stops IWDT on-chip oscillator



5.4 Writing the System Clock Control Register

Care should be taken when writing to the individual bit fields in the SCKCR register. The hardware manual states:

"To secure the processing after the clock frequency is changed, modify the pertinent clock control register to change the frequency, and then read the value from the register, and then perform the subsequent processing."

This means that every time a clock register is written, the user should read back the register and confirm the value has been changed before making any more modifications to other clock registers. The easiest way to avoid this situation and to ensure clock settings are correct is to write the entire register at once:

Unsafe	Safe
/*ICLK=96MHz*/	/* ICLK=96MHz
SYSTEM.SCKCR.BIT.ICK = 1;	PCLKA=96MHz
/*PCLKA=96MHz*/	PCLKB=48MHz
SYSTEM.SCKCR.BIT.PCKA = 1;	FCLK=48MHz
/*PCLKB=48MHz*/	BCLK=48MHz */
SYSTEM.SCKCR.BIT.PCKB = 2;	SYSTEM.SCKCR.LONG = (unsigned long)0x21021200;
/*FCLK=48MHz*/	
SYSTEM.SCKCR.BIT.FCK = 2;	
/*BCLK=48MHz*/	
SYSTEM.SCKCR.BIT.BCK = 2;	

5.5 Sample Code for Clock Setup

A separate application note covers software startup of the chip including setting the clocks for various applications. See the "Initial Setting" application note in the References section of this document.

5.6 HOCO accuracy

The internal high-speed on-chip oscillator (HOCO) runs at 50 MHz \pm -10% (refer to the Electrical Specifications in the hardware manual for details.

5.7 FlashIF Clock

The FlashIF Clock (FCLK) is used as the operating clock for when programming and erasing internal flash (ROM and DF) and for reading from the data flash. Therefore, the frequency setting of the FCLK will have a direct impact on the amount of time it takes to read from the data flash. If the user's program is reading from the data flash, or performing programming or erasures on internal flash, then using the maximum FCLK frequency is recommended.

Please note that the FCLK frequency does not have any impact upon reading from ROM or reading and writing to RAM. Both of these memory areas are always single-cycle access.

5.8 Board Design

Refer to the "Usage Notes" section of the Clock Generation Circuit chapter in the Hardware Manual for more information on using the CGC and for board design recommendations. A separate application note, "RX63N/RX631 Groups Design Guide for Low CL Sub-Clock Circuits" (R01AN1187EJ0100), provides details on board layout for clock circuits.

5.8.1 Important notes regarding the Oscillation Stop Detection Circuit

- The Oscillation Stop Detection circuit is disabled by default after reset, but may be enabled by writing to the OSTDE bit in the Oscillator Stop Detection Control Register (OSTDCR).
- If oscillation stop detection is enabled and an oscillation stop is detected then the system clock will automatically transition to the LOCO. The system clock will stay on the LOCO until the OSTDF flag in the OSTDSR register is



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cleared. In order to clear this flag the user must first change the CKSEL bits in the SCKCR3 register to choose the LOCO. After the flag has been cleared the user can transition back to the main clock or PLL. These steps are shown in the flow diagram from the hardware manual below.

- When transitioning to the LOCO, the PLL multipliers and frequency dividers chosen in the SCKCR# and PLLCR# registers are not changed.
- Because the main clock oscillator is turned off in the Software Standby and Deep Software Standby low power modes, the Oscillation Stop Detection circuit must be disabled before entering these modes.
- The Oscillation Stop Detection circuit must be disabled before the main clock oscillator is stopped by setting the MOSTP bit in the MOSCCR.
- To use the Non-Maskable Interrupt for oscillator stop, the OSTEN bit in Non-Maskable Interrupt Enable Register (NMIER) must be set.
- Oscillation stop detection should only be enabled after the main clock has had proper settling time.
- Application code servicing the Independent Watchdog Timer (IWDT) must take into account that the IWDT continues to run at the same rate even though the MCU is running at a reduced rate.
- The main clock provided to the RTC (RTCMCLK) is not transitioned to the LOCO. This means if the RTC has the main clock selected as the count source and an oscillation stop occurs then the RTC will not count due to not having a valid clock source.

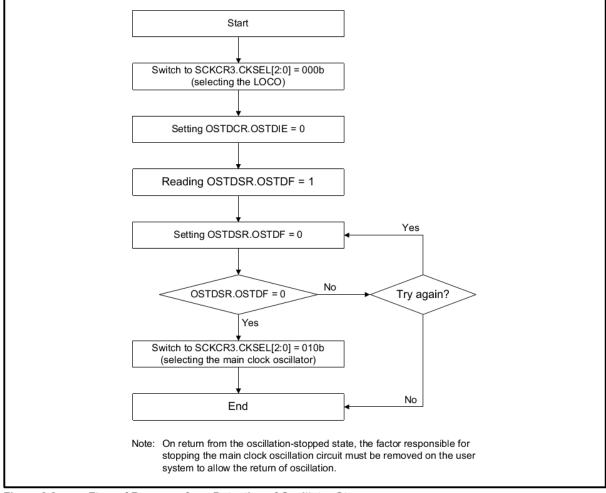


Figure 9.8

Flow of Recovery from Detection of Oscillator Stop



6. Reset Requirements and the Reset Circuit

There are nine types of resets:

Reset Name	Source
Pin reset	RES# is driven low
Power-on reset	VCC rices (voltage detection: VPOR)
Voltage-monitoring 0 reset	VCC falls (voltage detection Vdet0)
Voltage-monitoring 1 reset	VCC falls (voltage detection Vdet1)
Voltage-monitoring 2 reset	VCC falls (voltage detection Vdet2)
Deep software standby reset	Deep software standby mode is canceled by an interrupt
Independent watchdog timer reset	The independent watchdog timer underflows, or a refresh occurs
Watchdog timer reset	The watchdog timer underflows, or a refresh occurs
Software reset	Register setting

6.1 Pin Reset

When the RES# pin is driven low, all processing is aborted and the RX enters a reset state. To reset the MCU while it is running, RES# should be held low for the specified reset pulse width (minimum of 2 ms); RES# can be held low for a shorter time during ROM or data flash programming and erasure (200 µsec) and about 1ms in Deep Software Standby, Software Standby, and Low Speed-2 mode. Refer to the "Electrical Characteristics" chapter of the Hardware Manual for more detailed timing requirements. Also refer to section 2, "Emulator Support" for details on reset circuitry in relation to debug support.

There is no need to use an external capacitor on the RES# line because the POR circuit holds it low internally for a good reset and a minimum reset pulse of 2 ms is required to initiate this process.

6.2 Power-On Reset

The Power On Reset occurs when the RES# pin is high as power is applied to the MCU. After VCC has exceeded the power on voltage, Vpor (2.6V), and the power-on reset time, tPOR(4.6 ms) has elapsed, the chip is released from the power-on reset state. The power-on reset time is a period that allows for stabilization of the external power supply and the MCU.

Because the POR circuit relies on having RES# high concurrently with VCC, don't place a capacitor on the reset pin. This will slow the rise time of RES# in relation to VCC, preventing the POR circuit from properly recognizing the power-on condition.

If the RES# pin is high when the power supply (VCC) falls to or below Vpor, a power-on reset is generated. The chip is released from the power-on state after VCC has risen above Vpor and the tPOR has elapsed.

After a power on reset, the PORF bit in RSTSR0 is set to 1; following a pin reset PORF is cleared to 0.

6.3 Voltage-Monitoring Reset

The RX63N group includes circuitry that allows the MCU to protect against unsafe operation during brownouts. Onboard comparators check the supply voltage against three reference voltages, Vdet 0,Vdet1 and Vdet2. As the supply dips below each reference voltage an interrupt or a reset can be generated. Vdet0 is fixed (~ 2.8V) but Vdet1 and Vdet2 are configurable.

When Vcc subsequently rises above Vdet0, Vdet1 or Vdet2, release from the voltage-monitoring reset proceeds after a stabilization time has elapsed.

Low Voltage Detection (Vdet1 and Vdet2) is disabled by default after reset; Vdet0 can be enabled out of reset by using the Option Function register OFS1. For more details, see the chapter "Voltage Detection Circuit (LVD)" in the hardware manual for details.

After an LVD Reset, the LVDnRF (n= 0, 1, 2) bit in RSTSR0 is set to 1



6.4 Deep Software Standby Reset

This is an internal reset generated when deep software standby mode is canceled by an interrupt.

When deep software standby mode is canceled, a deep software standby reset is generated, and clock oscillation starts. On receiving the interrupt, after the Deep Standby Cancellation Wait Time (tDSBY ~370 µsec) has elapsed, reset is canceled and normal processing starts. For details of the deep software standby mode refer to the "Low Power Consumption" chapter of the hardware manual.

After a Deep Software Standby Reset, the DPSRSTF bit in RSTSR0 is set to 1

6.5 Independent Watchdog Timer Reset

This is an internal reset generated by the Independent Watchdog Timer (IWDT).

When the IWDT underflows, an independent watchdog timer reset is optionally generated (NMI can be generated instead) and the UNDFF bit in the IWDTSR is set to a 1. After a short delay (960 µsec), the IWDT reset is canceled.

6.6 Watchdog Timer Reset

This is an internal reset generated by the Watchdog Timer (WDT).

When the WDT overflows, a watchdog timer reset is optionally generated (NMI can be generated instead), and the WDTRF bit in RSTSR2 is set to a 1. After a short delay (960 µsec) the WDT reset is canceled.

6.7 Software Reset

This is an internal reset generated by writing 0xA501 to the SWRR register. The internal reset time when using software reset is a maximum of 960 µsec. When using software reset, make sure that the watchdogs are serviced first before issuing the software reset command.

6.8 Determining the Reset Source

The RX63N allows the user to determine the reset signal generation source. Refer to the hardware manual section 6.3.9 Determination of Reset Generation Source for the flow diagram.

The following code sample shows how to determine the source that caused a reset.



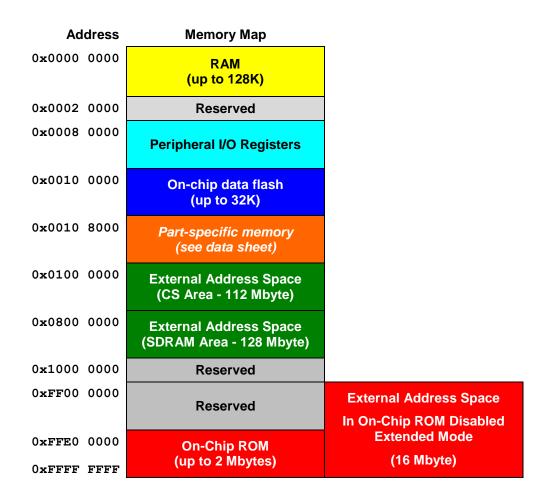
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```
#define RST_SRC_SW 0x001 /* Software reset */
#define RST_SRC_DSSTDBY 0x002 /* Deep software standby reset */
#define RST_SRC_VDET2 0x004 /* Voltage monitor 2 reset */
#define RST_SRC_VDET1 0x008 /* Voltage monitor 1 reset */
#define RST_SRC_WDT 0x010 /* Watchdog timer reset */
#define RST_SRC_IWDT 0x020 /* Independent watchdog reset */
#define RST_SRC_VDET0 0x040 /* Voltage monitor 0 reset */
#define RST_SRC_POR 0x080 /* Power on reset */
#define RST_SRC_POR 0x100 /* Pin reset */
 #define RST SRC PIN
                                        0x100 /* Pin reset */
int ResetSource ()
 {
   /* Check for software reset */
   if (SYSTEM.RSTSR2.BIT.SWRF == 1) return (RST SRC SW) ;
   /* Check for deep software standby reset */
   if (SYSTEM.RSTSR0.BIT.DPSRSTF == 1) return (RST SRC DSSTDBY) ;
    /* Check for voltage monitoring reset on Vdet2 */
   if (SYSTEM.RSTSR0.BIT.LVD2RF == 1) return (RST SRC VDET2) ;
   /* Check for voltage monitoring reset on Vdet1 */
   if (SYSTEM.RSTSR0.BIT.LVD1RF == 1) return (RST SRC VDET1) ;
   /* Check for watchdog timer (WDT) reset */
   if (SYSTEM.RSTSR2.BIT.WDTRF == 1) return (RST SRC WDT) ;
   /* Check for independent watchdog timer (IWDT) reset */
   if (SYSTEM.RSTSR2.BIT.IWDTRF == 1) return (RST_SRC_IWDT) ;
    /* Check for voltage monitoring reset on Vdet0 */
   if (SYSTEM.RSTSR0.BIT.LVDORF == 1) return (RST SRC VDET0) ;
   /* Check for power on reset */
   if (SYSTEM.RSTSR0.BIT.PORF == 1) return (RST_SRC_POR) ;
   /* If no other reset sources were indicated, then it must have been a pin reset */
   return (RST SRC PIN) ;
 }
```



7. Memory

The RX600 Series of MCU's have a 32-bit memory space spanning 4 Gbyte that includes areas for on-chip memory and peripherals. Some members of the family include a 256 Mbyte region that allows access to devices connected to external memory buses. Program and data memory share the address space; separate buses are used to access each, increasing performance and allowing same-cycle access of program and data. Contained within the memory map are regions for on-chip RAM, peripheral I/O registers, program ROM and data flash, and external memory.



7.1 On-Chip RAM

Members of the RX family include high-speed on-chip RAM that can be accessed in a single cycle at CPU speeds up to 100 MHz. Data stored in RAM is retained in all low-power modes of the CPU; the entire RAM or a portion of it may be powered down during Deep Software Standby Mode to further reduce power consumption. Depending on the RX device, up to 128K of on-chip RAM is accessed starting at address 0x00000000.

7.2 Peripheral I/O Registers

Blocks of peripheral I/O registers appear at various locations in the memory map depending on the device and the current operating mode. The majority of peripheral I/O registers occupy a region from address 0x00080000 to 0x00100000. This region contains registers that are available at all times in all modes of operation. Other blocks of peripheral registers, such as those to control access flash memory, vary in location and size by device; consult the hardware manual for specifics. The Renesas tool chain generates C header files that map all of the peripheral I/O registers for a specific device to easily accessible C data structures.

7.3 Program ROM & Data Flash

The RX600 Series of MCUs feature two flash memory sections: program ROM and data flash. The program ROM is designed to store user application code and constant data. The data flash is designed to store information that may be updated from time to time such as configuration parameters, user settings, or logged data. The units of programming and erasure in the data flash area are much smaller than that of the program ROM (2 bytes for Data Flash versus 128



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bytes for ROM). This makes the data flash more suited for storing information that would benefit from the finer granularity of the data flash area, such as configuration parameters.

Both the data flash and ROM areas can be programmed or erased by application code. This enables field firmware updates without having to connect an external programming tool. To speed development of code that supports in-application programming of the flash, Renesas supplies a "Simple Flash API for RX" application note that includes sample code. This application note can be found on the Renesas web site; see chapter 15 - References.

One some RX600 Series MCUs another flash area is available to the user. This small flash area can be used along with User Boot Mode to hold a custom bootloader that the user designs. This area cannot be erased or programmed during normal user application execution which makes it ideal for storing a bootloader.

7.3.1 Enabling Data Flash Memory

Out of reset the data flash memory cannot be read, programmed, or erased. In order to allow these accesses the data flash must be enabled. There are two sets of registers in the data flash that enable these types of accesses. The first are the E2 Data Flash Read Enable Registers (DFLRE#) which enable read capabilities on individual data flash blocks. The second are the E2 Data Flash P/E Enable Registers (DFLWE#) which allow programming and erasing operations on individual data flash blocks. Both sets of registers are 16-bits wide and require a key to be written along with the desired settings.

7.3.2 Blank Checking of Data Flash Memory

Data flash locations on the RX cannot be checked for blank (i.e. erased) by comparing the read value to 0xFF. The reason for this is that RX data flash cells actually have 2 cells per bit (compared to 1 cell per bit for ROM). This means that there are 4 different states the bit can be in; though only 3 are used: undefined, 0, and 1. Erased data flash locations on the RX have a value of undefined (not 0 or 1) and therefore the read bit value cannot be used to determine if the bit is erased. When a data flash bit is programmed, one of the cells is always changed depending on whether a 0 or 1 is being written. If the user wishes to know if a data flash location is erased then they should use the blank check command in the Flash Control Unit. The "Simple Flash API for RX Application Note" also includes an API function that serves this purpose.

7.3.3 Background Operation

RX600 MCUs support background operations for ROM and data flash. This means that when a program or erase is started, the user can keep executing and accessing memory from memory areas other than the one being operated on. For example, the CPU can execute application code from ROM while the data flash memory is being erased or programmed. Also, the CPU can execute application code from RAM while the ROM memory is being erased or programmed. The only exception to this rule is that the data flash cannot be accessed during ROM programming or erasing.

7.3.4 Data Flash in Low-Speed Operating Mode 2

The data flash cannot be accessed when the MCU is in low-speed operating mode 2. If the MCU transitions into another operating mode then the data flash can be accessed normally.

7.3.5 ID Code Protection

RX600 MCUs have a 32-byte memory area that is used as an ID code. If this ID code is left blank (0xFF's) then no protection is enabled and access to the MCU is allowed through boot mode or using the on-chip debugger. If the ID code is set then the user can control access to these modes. The user can choose to always disallow connections, or can choose to allow connections when a matching ID code is input. Refer to the "ID Code Protection (Boot Mode)" and "ID Code Protection on Connection of the On-Chip Debugger" sections of the hardware manual for more information.

7.3.6 Parallel Programmer Protection

RX600s MCU have the ability to limit what operations parallel ROM programmers can perform on the MCU. The choices include allowing both reading and writing, prohibiting writing, and prohibiting writing and reading. Which option is chosen is performed by setting a constant value at specified memory address. See 'ROM Code Protection' in the hardware manual for more details.

7.4 External Memory & Chip Selects

Some members of the RX family include an external data bus for connection to external memory and devices. Some members also include a built-in SDRAM controller that allows the use of up to 128 Mbytes of external SDRAM. Eight programmable chip selects provide a number of options that are settable on a per-chip select basis to allow connection to a wide range of external devices. The external chip select area of the memory map begins at address 0x0100 0000. Consult the hardware manual for details.



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The external memory bus is off by default and must be enabled through writing to a number of registers. The SYSCR0.EXBE bit must be set (see chapter 3 of the HW manual), followed by the setting the pin functions in the Multi-Function Pin Controller (chapter 22 of the HW manual), and then registers that control the external bus (chapter 16 of the HW manual). Review these chapters carefully as there are specific constraints on how to write the registers.

7.4.1 Special note about CS0

Chip select zero is mapped in memory to the same space as the internal ROM of the device. When using chip select zero, the device boots out of internal ROM. Application code must then enable CS0 and disable on-chip ROM. The ROM is disabled by clearing the SYSCR0.ROME bit (see chapter 3 of the HW manual). When disabling on-chip ROM, the on-chip data flash is also disabled. Once on-chip ROM is disabled it cannot be re-enabled without resetting the chip. *Users are advised not to use chip select zero unless they have very specific reasons for doing so.*

7.4.2 Using External 16-bit Memory Devices

When connecting an external 16-bit memory device that has a byte select line, connect A1 of the MCU to A0 of the memory and A0 of the MCU to the byte select line.

7.5 Memory Access Speed

Both the RAM and internal ROM can be accessed in a single cycle with no wait states. This is true to up to the current maximum operating frequency of the RX600 Series, which is 100MHz. The system peripheral clock limits speed when accessing peripheral I/O registers. An example: if the clocks are set at their maximums (System clock: 100MHz, Peripheral Clock B: 50MHz), it will take 2 CPU cycles to access a peripheral I/O register. Accesses to the data flash are controlled by the FlashIF Clock (FCLK). The data flash memory takes 6 cycles of the FCLK to read 1 or 2 bytes.

7.6 Data Alignment

There are no limits for aligning data. The MCU is capable of doing byte, word, and long accesses on odd memory locations. While it is still optimal to align data accesses, it is not required.



8. Register Write Protection

The Register Write Protection function protects certain registers in the MCU from inadvertent changes. The system Protect Register (PRCR) contains bits that enable writing to other registers in the MCU. PRCR is a sixteen bit register with a key in the upper byte and the protection bits in the lower byte. A key code of A5 hex must be written to the upper 8 bits of PRCR to modify any of the lock bits in the lower byte. Setting a PRC bit to a 1 allows writing of the protect registers. Protection is enabled by default after reset (all PRC bits are zero after reset).

Figure 2 - PRCR Register

b15	b14	b13	b12	b11	b10	b9	b8	b7	b6	b5	b4	b3	b2	b1	b0
			PRKE	Y[7:0]					_			PRC3		PRC1	PRC0

Table 7 - PRCR Protection Bits

PRCR bit	Description
PRC0	 Registers in the Clock Generation Circuit (CGC) that control operation of the MCU's clocks: SCKCR, SCKCR2, SCKCR3, PLLCR, PLLCR2, BCKCR, MOSCCR, SOSCCR, LOCOCR, ILOCOCR, HOCOCR, OSTDCR, OSTDSR
PRC1	 Registers related to the operating modes: SYSCR0, SYSCR1
	 Registers related to the low power consumption functions: SBYCR, MSTPCRA, MSTPCRB, MSTPCRC, OPCCR, RSTCKCR, MOSCWTCR, SOSCWTCR, PLLWTCR, DPSBYCR, DPSIER0 to DPSIER3, DPSIFR0 to DPSIFR3, DPSIEGR0 to DPSIEGR3
	 Registers related to clock generation circuit: MOFCR, HOCOPCR
	Software reset register: SWRR
PRC3	 Registers related to the Low Voltage Detection circuit (LVD): LVCMPCR, LVDLVLR, LVD1CR0, LVD1CR1, LVD1SR, LVD2CR0, LVD2CR1, LVD2SR
PRKEY[7:0]	Write 0xA5 to these bits to allow writing to the PRC bits. To modify the system protection, write 0xA5 to the PRKEY bits while setting the PRC bits.

8.1 System Protection Example code

To unlock all registers, write 0xA50B to the PRCR. Set it back to 0xA500 to protect them all again.

```
/* Disable write protection for all protected registers */
SYSTEM.PRCR.WORD = 0xA50B;
/* Change system clock divisors */
SYSTEM.SCKCR.LONG = 0x21031222 ;
/* Turn write protection back on for all protected registers */
SYSTEM.PRCR.WORD = 0xA500;
```



9. I/O Ports and Register Structures

Renesas supplies a C language header file named 'iodefine.h' that allows users to easily access I/O registers through unions and structures. The syntax of using these unions and structures to access hardware registers is:

Peripheral.Register<.AccessWidth>.<Bit>

Where:

Peripheral is the name of a specific peripheral such as: SCI0, ICU, AD0, etc.

Register is the register abbreviation for a specific register such as: SCR, IPR, ADCR, etc.

AccessWidth is an optional field used when an I/O register has more than one field. One of four keywords specifies how to access the register: LONG, WORD, BYTE, or BIT.

Bit is an optional field that is only used when *AccessWidth* is BIT. It specifies the name of a single bit or range of bits in a register such as: TIE, IPR, or MODE.

Note that Peripheral, Register, and Bit match the mnemonics used in the RX Hardware Manual.

If accessing a register that does not have bit fields, use the peripheral and register name only. An example is 'MTU0 Timer Counter' shown in the table below.

What to access	Bits to Access	How to access
System Clock Control Register (SCKCR)	32	SYSTEM.SCKCR.LONG
MTU0 Timer Counter	16	MTU0.TCNT
SCI Channel 3, Receive Data Register (RDR)	8	SCI3.RDR
SCI Channel 3, Serial Control Register (SCR)	8	SCI3.SCR.BYTE
SCI Channel 3, Receive enable bit in SCR	1	SCI3.SCR.BIT.RE
Port 2, Pin 5, Port Direction Register Bit	1	PORT2.PDR.BIT.B5
Counter Clear bit field in TMR0 TCR register	2	TMR0.TCR.BIT.CCLR
CMT0 Compare Match Timer Control Register	16	CMT0.CMCR.WORD

9.1 I/O Register Macros

New macros in the iodefine.h for RX family parts make it easier to refer to ICU control registers, module stop registers, DTC enable registers, and interrupt vector numbers by the logical names associated with the peripherals. These macros allow portability across RX family members by hiding specific register and vector numbers. See the documentation contained in iodefine.h and sections below for details.

Some examples:

Macro	Usage example
<pre>IR("module name", "bit name")</pre>	if (IR(SCI0,TXI0) == 1)
<pre>IEN("module name", "bit name")</pre>	<pre>IEN(SCI0,TXI0) = 1 ;</pre>
IPR("module name", "bit name")	$IPR(SCI0, TXI0) = 0 \times 02$;
MSTP("module name")	MSTP(SCI0) = 0 ;
<pre>VECT("module name", "bit name")</pre>	<pre>#pragma interrupt (MySciTxIsr(vect=VECT(SCI0,TXI0))</pre>



9.1.1 ICU Register Macros

These macros help with accesses to the following registers in the ICU:

- Interrupt Request Registers (IRn)
- DTC Activation Enable Register (DTCERn)
- Interrupt Request Enable Register (IERm)
- Interrupt Priority Register (IPRm)

Instead of having to refer to the values for 'n' and 'm', the user can specify the desired peripheral and interrupt. Application code then becomes portable across members of the RX family that share the same peripheral.

Examples are below.

Without Macro	With Macro
ICU.IR[176].BIT.IR = 0;	IR(TMR2, CMIA2) = 0;
ICU.DTCER[176].BIT.DTCE = 1;	DTCE(TMR2, CMIA2) = 1;
ICU.IER[0x16].BIT.IEN0 = 1;	IEN(TMR2, CMIA2) = 1;
ICU.IPR[176].BIT.IPR = 3;	IPR(TMR2, CMIA2) = 3;

9.1.2 Vector Number Macro

When using the Renesas compiler, interrupt service routines written in C language are hooked to specific interrupts vectors using the #pragma interrupt directive:

```
#pragma interrupt (INT_RXI0(vect=214))
void INT RXI0 (void) ;
```

The above example hooks the C language function "INT_RXI0" to interrupt vector number 214, which is the receive interrupt for SCI0. This same interrupt source (RXI0) may not use the same vector number (214) on other members of the RX family. To provide portability, the **VECT**() macro allows the user to specify a logical name for an interrupt source which is then expanded by a part-specific iodefine.h file to the correct vector number.

The syntax is:

VECT(Peripheral, Source)

Where:

Peripheral is the name of a specific peripheral such as: SCI0, TMR2, AD0, etc.

Source is the name of an interrupt source in that peripheral such as: RXI0, CMIA2, ADI0, etc.

Example:

Without Macro

```
/* Declare ISR for TMR2 - CMIA2 */
#pragma interrupt TMR2 CMIA2(vect=176)
```

With Macro

```
/* Declare ISR for TMR2 - CMIA2 */
#pragma interrupt TMR2_CMIA2(vect=VECT(TMR2,CMIA2))
```



9.1.3 Module Stop Control Macro

The Module Stop Control Registers allow individual peripherals to be turned on or off for power savings. By default, most peripherals are off at power up and must be powered on before accessing their control registers (see hardware manual for details). The Module Stop Control Registers contain bit fields for a number of peripherals; these registers change in layout from part to part in the RX family. The **MSTP()** macro simplifies control of the stop state of peripherals and makes code portable.

To use this macro, specify the name of the peripheral:

MSTP (Peripheral)

Example:

Without Macro	With Macro
/* Turn on TMR2 */	/* Turn on TMR2 */
SYSTEM.MSTPCRA.BIT.MSTPA4 = 0;	MSTP(TMR2) = 0;

Care should be taken when using the MSTP() macro because sometimes multiple peripheral channels will map to the same MSTP bit. For example, the MSTPA15 bit controls CMT0 and CMT1 (both channels are part of CMT unit 0). This means that both MSTP(CMT0) and MSTP(CMT1) will resolve to SYSTEM.MSTPCRA.BIT.MSTPA15. This is not a problem when powering on a peripheral but could cause a problem when powering down. If the user turns off CMT0 to save power by using 'MSTP(CMT0) = 1;' then they will also turn off CMT1 even if they did not intend to. The user can avoid this problem by always checking to make sure both channels are not in use before powering down.

9.2 I/O Registers and Endian Settings

The RX I/O Registers are at fixed locations and byte orders in memory regardless of the endian setting of the processor. When accessing data memory, the most significant byte of a 16-bit word can be stored at either an odd or even address depending on the endian setting; this is not the case with the RX I/O Registers.

Always access I/O registers using the proper access instruction for the size of the register; do not access word or long word registers with byte instructions, or long word registers with word instructions. Do not assume that registers for a particular peripheral are big-endian or little-endian.

This can confuse some compilers depending on the data structures used to access I/O Registers, particularly when using bit fields in 16-bit or wider registers. The iodefine.h file generated by the Renesas tools uses directives specific to the Renesas compiler (such as "___evenaccess") to ensure that access to the I/O registers is correct regardless of the endian setting of the processors.

Because of this:

The user is strongly advised to use only the structures in iodefine.h file to access I/O registers

and

to check the compiler output at the assembly language level if changes are made to the file.



10. I/O Port Configuration and the Multifunction Pin Controller (MPC)

The I/O Ports and MPC sections of the Hardware Manual describe exact pin configurations based on peripheral selection and other register settings. Some general information is listed below.

10.1 Setting Up and Using Port as GPIO

- Select a pin as an output by writing a "1" to the corresponding Port Direction Register (PDR)
- The Port Direction Register (PDR) is read/write. Setting the value to a "1" selects the pin as an output. Default state for I/O Ports is "0" (input). The port direction registers can be read on the RX.
- The Port Output Data Register (PODR) is read/write. When the PODR is read the state of the output data latch (not the pin level) is read.
- The Port Input Register (PIDR) is read only. Read the PIDR register to read the pin state.
- The Port Mode Register (PMR) is read/write and is used to specify whether individual pins function as GPIO or as peripheral pins. Out of reset all PMR registers are set to 0 which sets all pins to work as GPIO. If a PMR register is set to 1 then that corresponding pin will be used for peripheral functions. The peripheral function is defined by that pin's MPC setting.
- When setting a pin as an output it is recommended that the desired output value of the port be written to the data latch first, then the direction register is set to an output. Though not important in all systems, this prevents an unintended output glitch on the port being setup.

Examples:

Set up Port 0, bit 1 as an input:

```
/* Make pin an input */
PORT0.PDR.BIT.B1 = 0;
/* See if input is high */
if (PORT0.PIDR.BIT.B1 == 1) ...
```

Set up Port 0, bit 1 as an output:

```
/* Set the output level first to prevent glitches */
PORT0.PODR.BIT.B1 = 1;
/* Make pin an output */
PORT0.PDR.BIT.B1 = 1;
```

10.1.1 Internal Pull-Ups

- Each pin on ports 0 through 9, A through G, and J has the option of enabling a pull-up resistor. The pull-up is controlled by the Pull-Up Resistor Control Register (PCR). Each bit in the PCR register controls the corresponding pin on the port. Set the PCR bit to "1" to enable the pull-up and to "0" to disable it.
- Out of reset all PCR registers are cleared to 0 therefore all pull-up resistors are disabled.
- The pull-up is automatically turned off whenever a pin is designated as an external bus pin, a GPIO output, or a peripheral function output pin.

10.1.2 Open-Drain Output

- Pins configured as outputs normally operate as CMOS outputs.
- Each pin on ports 0 through 9, A through G, and J has the option being configured as a NMOS open-drain output.
- The Open Drain Control Registers (ODR0 & ODR1) control which pins operate in open-drain mode. The ODR0 registers control the settings for pins 0 through 3 on each port. The ODR1 registers control the settings



for pins 4 through 7 on each port. Setting the applicable bit in each register to a "1" makes the output opendrain.

• Because of parasitic diodes on the RX port pins, maximum voltage to open drain outputs must be limited to VCC.

10.1.3 Drive Capacity

- Each pin on ports 0, 2, 5, 9, A to E, and G has the option of enabling high-drive output. Whether normal or high drive is enabled is controlled by the Drive Capacity Control Registers (DSCR).
- Out of reset all DSCR registers are cleared to 0 therefore all pins are set to normal drive output. Setting "1" to a DSCR bit will enable high-drive output for the selected pin.
- The maximum total output of all pins summed together is 80mA.
- The differences between normal and high drive are shown below:

	Drive Capacity	Max (mA)
Permissible output current per pin (average)	Normal Drive	2.0
Permissible output current per pin (average)	High Drive	3.8
Permissible output current per pin (maximum)	Normal Drive	4.0
Permissible output current per pin (maximum)	High Drive	7.6

10.2 Setting Up and Using Port Peripheral Functions

The Multi-Function Pin Controller (MPC) is a new feature on the RX63x that replaces the Port Function Control registers on the RX62x. The result is a much more flexible assignment of pins to peripherals functions, with a much finer granularity of selection.

- Since many pins have multiple functions the RX63N/RX631 Group has Pin Function Control Registers (PmnPFS where m = port, n = pin) that allow you to change the function assigned to a pin.
- Each pin has its own PmnPFS register. For example, the P10PFS register allows you to choose whether you want port 1 pin 0 to be assigned to the MTU or TMR peripheral.
- Each PmnPFS register allows a pin to be used for peripheral function (PSEL bits), as an IRQ input pin (ISEL bit), or as an analog input pin (ASEL bit). If the ASEL bit is set to "1" (use pin as analog input pin) then the pin's PMR bit should be set for GPIO use and the pin's PDR bit should be set for input.
- Refer to the appropriate register under Multi-Function Pin Controller (MPC) >> Register Descriptions in the HW manual for a table of the available peripheral functions for each pin.
- In order to ensure that no unexpected edges are input or output on peripheral pins make sure to clear the PMR bit for the targeted pin before modifying the pin's PmnPFS register.
- All PmnPFS registers are write protected out of reset. In order to write to these registers the Write-Protect Register (PWPR) must first be used to enable writing.
- Care should be taken when setting PmnPFS registers such that a single function is not assigned to multiple pins. The user should not do this but the MCU will allow it. If this occurs the function on the pins will be undefined.
- If you are using the external bus, the Ethernet controller, or USB, there are additional registers in the MPC that must be configured before using these peripherals.
- The example below shows the steps for setting port 0, bit 1 to be a SCI receiver input pin (RXD6). These steps are defined in the Multi-Function Pin Controller (MPC) >> Usage Notes >> Procedure for Specifying Input/Output Pin Function section of the RX63N HW manual.



Example - Enabling SCI6 to use port 0, bit 1 as SCI receiver input pin

```
/* Allow writing to MSTP registers. */
SYSTEM.PRCR.WORD = 0 \times A50B;
/* Enable SCI6 (take out of stop mode) */
MSTP(SCI6) = 0;
/* Configure SCI6. */
. . .
/* Clear PMR bit for P0 1 before changing P01PFS register. */
PORT0.PMR.BIT.B1 = 0;
/* Set PO 1 as input pin. */
PORT0.PDR.BIT.B1 = 0;
/* Unlock protection register */
MPC.PWPR.BIT.BOWI = 0;
/* Unlock MPC registers */
MPC.PWPR.BIT.PFSWE = 1;
/* Set P0 1 to be used for RXD6 function. */
MPC.P01PFS.BYTE = 0 \times 0A;
/* Assign P0 1 to be used for peripheral function. */
PORT0.PMR.BIT.B1 = 1;
/* Set other port registers and re-enable MPC & MSTP register protection. */
```

10.3 Setting Up and Using IRQ Pins

- Certain port pins can be used as hardware interrupt lines (IRQ). See the Multi-Function Pin Controller (MPC) >> Overview section of the HW Manual for information on which pins are available for your MCU. When looking through the list of available IRQ pins you will notice that some have a "-DS" postfix (e.g. IRQ1-DS). The "-DS" designates that this pin can be used to wake the MCU out of deep software standby mode.
- To set a port pin to be used as an IRQ pin, the Interrupt Input Function Select bit (ISEL) in the pin's PFS register must be set to "1".
- Pins can be used for both IRQ and peripheral functions simultaneously. To enable this the user should set both the ISEL and PSEL bits in the pin's PFS register.
- IRQ pins can trigger interrupts on detection of:
 - o Low level
 - Falling edge
 - Rising edge
 - Rising and falling edges

Which trigger is selected is chosen using the IRQ Control Registers (IRQCRi).

- Digital filtering is available for IRQ pins. The filters are based on repetitive sampling of the signal at one of four selectable clock rates (PCLK, PCLK/8, PCLK/32, PCLK/64). They filter out short pulses: any high or low pulse less than 3 samples at the filter rate. The filters are useful for filtering out ringing and noise in these lines, but are much too quick for filtering out long events like mechanical switch bounce. Enabling filtering adds a short bit of latency (the filter time) to the hardware IRQ lines.
- Digital filtering can be enabled for each IRQ pin independently. This is done by setting the IRQ Pin Digital Filter Enable Registers (IRQFLTEi).
- The clock rate for digital filtering is configurable for each IRQ pin independently. This is done by setting the IRQ Pin Digital Filter Setting Registers (IRQFLTCi).
- The example below shows code to enable IRQ8 with falling edge detection on port 4, pin 0.



Example - Enabling port 4, bit 0 as IRQ8 input

```
/* P4 0 is not being used for peripheral function. */
PORT4.PMR.BIT.B0 = 0;
/* Make pin an input */
PORT4.PDR.BIT.B0 = 0;
/* Unlock protection register */
MPC.PWPR.BIT.BOWI = 0;
/* Unlock MPC registers */
MPC.PWPR.BIT.PFSWE = 1;
/* Set P4 0 to be used for IRQ8 function. */
MPC.P40PFS.BYTE = 0x40;
/* Set IRQ type (falling edge) */
ICU.IRQCR[8].BIT.IRQMD = 0x01;
/* Clear any pending interrupts. */
IR(ICU, IRQ8) = 0;
/* Set interrupt priority to 3 */
IPR(ICU, IRQ8) = 0 \times 03;
/* Enable the interrupt */
IEN(ICU, IRQ8) = 1;
/* Be sure to write an interrupt handler !!! */
```

10.4 Unused Pins

NOTE:

Some pins require specific termination: See the "I/O Ports: Handling of Unused Pins" section of the Hardware Manual for specific recommendations.

Unused pins that are left floating can consume extra power and leave the system more susceptible to noise problems. Terminate unused pins with one of the methods detailed here:

- 1. The first option is to set the pin to an input (the default state after Reset) and connect the pin to Vcc or Vss using a resistor. There is no difference from a MCU standpoint between one connection or another; however, there may be an advantage from a system noise perspective. Vss is probably the most typical choice. Avoid connecting a pin directly to Vcc or Vss since an accidental write to the port's direction register that sets the pin to an output could create a shorted output.
- 2. A second method is to set the pin to an output. It does not matter whether the pin level is set high or low; however, setting the pin as an output and making the output low connects the pin internally to the ground plane. This may help with overall system noise concerns. A disadvantage of setting unused pins to outputs is that the configuration of the port must be done via software control. While the MCU is held in Reset and until the direction register is set for output the pin will be a floating input and may draw extra current. If the extra current can be tolerated during this time, this method eliminates the external resistors required in the first method.
- 3. A variation on leaving the pins as inputs and terminating them with external resistors uses the internal pull-ups available on some ports of the MCU. This has the same limitation as setting the pins to outputs (requires the program to set up the port) but it does limit the effect of accidental pin shorts to ground, adjacent pins or Vcc since the device will not be driving the pin.

10.5 Nonexistent Pins

When using a MCU with less than 177 or 176 pins, set the corresponding bits of nonexistent ports in the PDR register to "1" (output) and in the PODR register to "0". The user can see which ports are available on each MCU package by reviewing the "Specifications of I/O Ports" table in the I/O Ports section of the HW Manual. For example pins 0 and 1 on port 1 are only available on 177 and 176 pin packages. A separate application note covers software startup of the chip including initialization of nonexistent pins. See the "Initial Setting" application note in the References section of this document.



10.6 Electrical Characteristics

GPIO require CMOS level inputs (High ≥ 0.8 * Vcc, Low ≤ 0.2 *Vcc) see electrical characteristics for more information

10.7 MPC Register Setting Summary

The following table can be found in section 22.4 of the Hardware Manual. Additional information can be found there.

				PmnPF	S	
Item	PMR.Bn	PDR.Bn	ASEL	ISEL	PSEL[4:0]	Point to note
After a reset	0	0	0	0	00000b	Pins function as general input port pins after release from the reset state.
General input ports	0	0	0	0/1	X	Set the PmnPFS.ISEL bit to 1 if these are multiplexed with interrupt inputs.
General output ports	0	1	0	0	X	
Peripheral functions	1	X	0	0/1	Peripheral function setting	Set the PmnPFS.ISEL bit to 1 if these are multiplexed with interrupt inputs.
Interrupt inputs	0	0	0	1	Х	
NMI	Х	Х	Х	X*	Х	Register settings are not required
Analog inputs and outputs	0	0	1	X*	X	Set these as general input port pins so that the output buffers are turned off
Time-capture event- input pins	0	0	Х	0/1	X	Set these as general input port pins so that the output buffers are turned off.
External bus	0	Х	0	0	X	Set the PMR.Bn bit and the PmnPFS.ISEL bit to 0 and switch the input buffers off
JTAG-IF	0	Х	Х	0	X	Set the PMR.Bn bit and the PmnPFS.ISEL bit to 0 and switch the input buffers off
FINE interface	0	X	Х	0	X	Set the PMR.Bn bit and the PmnPFS.ISEL bit to 0 and switch the input buffers off
EXTAL/XTAL	0	0	Х	X*	Х	Set these as general input port pins so that the output buffers are turned off
XCIN/XCOUT	0	0	Х	X*	Х	Set these as general input port pins so that the output buffers are turned off.

X: setting not required

0/1: Setting the PmnPFS.ISEL bit to 0 makes the pin incapable of functioning as an IRQ pin.

Setting the PmnPFS.ISEL bit to 1 makes the pin capable of functioning as an IRQ pin

*Even if the PmnPFS.ISEL bit is set to 1, the pin will not function as an IRQn input pin.



11. Module Stop Function

To maximize power efficiency, the RX family of MCU's allow on-chip peripherals to be shut down individually by writing to the Module Stop Control Registers (MSTPCRi, i=A, B, C). After reset most of the modules are stopped (exceptions are DMAC, EXDMAC, DTC, and on-chip RAM; see hardware manual for details).

Before accessing any of the registers for a peripheral, it must be enabled by taking out of stop mode by writing a '0' to the corresponding bit in the MSTPCRi register. The MSTPCRi registers are protected registers and they have to be unprotected by writing to the PRCR registers first (see section 8 - Register Write Protection). See example below.

Peripherals may be shut down by writing a '1' to the proper bit in the MSTPCRi register.

The MSTP() macro in iodefine.h makes it easy to enable and disable peripherals using their name.

Example - Turning on SCI6 using the MSTP macro

```
/* Disable write protection for the MSTP registers */
SYSTEM.PRCR.WORD = 0xA502;
/* Enable SCI6 (take out of stop mode) */
MSTP(SCI6) = 0 ;
/* Enable write protection for the MSTP registers */
SYSTEM.PRCR.WORD = 0xA500;
/* You can now access SCI6 control registers */
```



12. Interrupts

The RX family has a sophisticated Interrupt Control Unit (ICU) that handles asynchronous events from over 200 sources. These sources include on-board peripherals, external hardware, and software requests. The Interrupt Control Unit chapter of the Hardware Manual lists each source for specific parts.

Local interrupt enable flags in each peripheral gate a signal from the peripheral to the ICU. These signals set Interrupt Status Flags in individual ICU Interrupt Request registers (IRx) that exist for each interrupt source. Within the ICU, individual bits in the Interrupt Request Enable Registers (IERx) determine whether an interrupt is taken when the Status Flag becomes set.

To handle simultaneous interrupt requests from multiple sources, the ICU allows each interrupt source to be assigned a priority. These priorities are compared to the current priority level in the CPU status register IPL bits, and an interrupt is only serviced if its priority is greater than the CPU's current IPL and all other active requests. Two active sources with the same priority level are serviced in vector number order, lowest vector first.

The steps to enable an interrupt are:

- 1. The peripheral or port pin generating the interrupt must be enabled and configured in both the Port setup registers and the Multifunction Pin Controller Registers.
- 2. Set an interrupt priority for the interrupt source (IPR macro) to a value greater than zero (zero = disabled).
- 3. Enable the interrupt in the peripheral (local enable bit)
- 4. Enable the interrupt in the ICU (IEN macro)

For edge-triggered interrupts, the Interrupt Status Flags in the IR registers are cleared automatically when an interrupt fires and the CPU vectors to the Interrupt Service Routine (ISR). The flags must be manually cleared when using polled operation rather than interrupts.

For level-sensitive interrupts, the Interrupt Status Flag in the IR register stays set until the interrupt source is cleared.

12.1 Nesting Interrupts

The global interrupt enable bit in the Processor Status Word (PSW), the 'I' bit, is cleared whenever an interrupt is taken, disabling all further interrupts including higher priority interrupts. To allow nesting of interrupts and pre-emption of the ISR by higher priority interrupts, the 'I' bit must be set in the ISR. When declaring an interrupt in C (#pragma interrupt), use the 'enable' keyword to automatically set the 'I' bit when the interrupt is taken. Refer to RX compiler manual for more info.



12.2 Interrupt Vector Tables

The RX family has a fixed interrupt vector table and a relocatable interrupt vector table. Each vector in the vector table consists of four bytes and specifies the address where the corresponding exception handler starts.

12.2.1 Fixed Vector Table

The fixed vector table is allocated to a fixed address range. The individual vectors for the privileged instruction exception, undefined instruction exception, floating-point exception, non-maskable interrupt, and reset are allocated to addresses in the range from FFFFF80h to FFFFFFFh. Also included in the fixed vector table are some locations that are reserved for system configuration and ROM protection. Figure 3- Fixed Vector Table shows the fixed vector table.

Address	Description				
FFFFFF80h	Endian select register (MDES) in single-chip mode				
FFFFFF84h	(Reserved)				
FFFFFF88h	Option Function Select Register 1 (OFS1)				
FFFFFF8Ch	Option Function Select Register 2 (OFS2)				
FFFFFF90h – FFFFFF98h	(Reserved)				
FFFFFF9Ch	ROM protection code				
FFFFFFA0h –	(Peppried)				
FFFFFFCCh	(Reserved)				
FFFFFFA0h –	ID Code for flash protection				
FFFFFACh					
FFFFFFD0h	Privileged instruction exception				
FFFFFFD4h	Access exception				
FFFFFFD8h	(Reserved)				
FFFFFFDCh	Undefined instruction exception				
FFFFFFE0h	(Reserved)				
FFFFFFE4h	Floating-point exception				
FFFFFE8h –	(Reserved)				
FFFFFFF4h					
FFFFFF8h	Non-maskable interrupt				
FFFFFFCh	Reset				

Do not store data in areas marked "Reserved" in the fixed vector table; some of these areas are used by the RX for specific functions such as the code protection mechanism. User data must be stored below address FFFF FF80h.

12.2.2 Relocatable Vector Table

The address where the relocatable vector table is placed can be adjusted. The table is a 1,024-byte region that contains all vectors for unconditional traps and interrupts and starts at the address (IntBase) specified in the interrupt table register (INTB). Figure 4 - Relocatable Vector Table shows the relocatable vector table.

Each vector in the relocatable vector table has a vector number from 0 to 255. Each of the INT instructions, which act as the sources of unconditional traps, is allocated to the vector that has the same number as that of the instruction itself (from 0 to 255). The BRK instruction is allocated to the vector with number 0. Furthermore, vector numbers within the set from 0 to 255 are also allocated to other interrupt sources, such as on-chip peripherals, on a per-product basis.

Note that the value of the Interrupt Table Register (INTB) is undefined after reset. The Renesas tool chain can automatically generate startup code that initializes the INTB register. INTB can only be changed when the MCU is in supervisor mode.



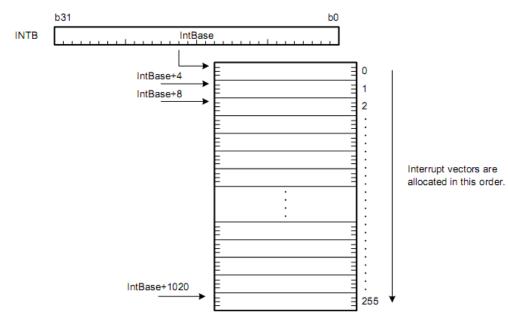


Figure 4 - Relocatable Vector Table

12.3 Fast Interrupts

For applications where interrupt response is critical, interrupt latency can be reduced through the use of the Fast Interrupt. The Fast Interrupt specifies one interrupt source in the Fast Interrupt Vector register (FINTV) as a high-priority interrupt, and uses dedicated registers for saving the Program Status Word (BPSW) and Program Counter (BPC). Further speed enhancements can be realized by instructing the compiler to reserve some of the general purpose CPU registers for exclusive use by the Fast Interrupt service routine. With a dedicated set of CPU registers reserved for its sole use, the response of Fast Interrupt service routine is improved by eliminating the need to save and restore processor context on the stack during entry and exit. The performance of the main application code may be slightly degraded due to the smaller register set available to it.

12.4 Interrupt Stack Pointers

A separate Interrupt Stack Pointer (ISP) is used during exception processing. This greatly reduces RAM requirements when using an RTOS since room for an interrupt stack does not need to be allocated as part of each task's stack. The ISP is automatically set by the startup code generated by the Renesas tool chain (see "Startup Program Creation" in the RX Software manual for details). Register R0 is used as the stack pointer and contains the current value of the active stack pointer (ISP or USP) depending on the processor mode.

12.5 Interrupt Request Groups

In some cases, interrupts from multiple sources are grouped into a single request group. Interrupt signals in each group are collectively handled by a single interrupt request and vector. Within each group, individual sources may be enabled or disabled. Refer to the Interrupt Control Unit (ICU) chapter in the hardware manual for details.

12.6 Interrupt Unit Selection

For some MTU and TPU interrupt sources, request from the two peripheral modules are handled as one interrupt request. The ICU can be set to service either the MTU or TPU interrupts through the single request and vector. Refer to the section "Unit Selection" in the Interrupt Control Unit (ICU) chapter in the hardware manual for details.



13. Low Power Consumption

The RX63N has register settings that allow the MCU to operate with lower power consumption. These modes are referred to as the Operating Power Control Modes and are controlled by the OPCCR register. Below is a summary of these modes and the maximum permissible clocking and voltage levels under each mode.

Operating Power Control Mode	OPCM [2] bits	Operating Frequency/Voltage Range							
	During Flash READ					During Flash PROGRAM/ERASE			
		ICLK (max)	FCLK (max)	PCLKA (max)	PCLKB (max)	BCLK (max)	Voltage V	FCLK	Voltage V
High Speed Operating Mode	000b	100 MHz	50 MHz	100 MHz	50 MHz	100 MHz	2.7-3.6	4-50 MHz	2.7-3.6
Low Speed Operating Mode 1	110b	1 MHz	1 MHz	1 MHz	1 MHz	1 MHz	2.7-3.6	P/E Disabled	P/E Disabled
Low Speed Operating Mode 2	111b	32 - 125 KHz	32 - 125 KHz	125 KHz	125 KHz	125 KHz	2.7-3.6	P/E Disabled	P/E Disabled

Note that while it may be possible to set the value in the OPCCR register to any of the low power operating modes, unless the clocking and voltage levels are not already set to meet the requirements of said mode, setting the OPCCR register will not have any effect in lowering power consumption.

In order to achieve the lowest power numbers, use the maximum possible dividers in the clock generation circuits.

In addition to the Operating Power Control Modes, the RX63N also has Low Power Consumption modes where the CPU is inactive and the other peripherals/clocks are switched on or off depending on how much power needs to be conserved. These modes are activated by configuring the appropriate control registers (refer to Figure 11.1 in the hardware manual) and then executing the wait() instruction.

Since the low power modes can be exited on receiving an interrupt, all pending requests should be handled and the I flag cleared prior to executing the wait() instruction.

The table below is a summary of the three Low Power Consumption modes:



Table 9 – Low Power Consumption Modes

State of operation	Sleep Mode	All-Module Clock Stop Mode	Software Standby Mode	Deep Software Standby Mode
Transition condition	Control register + instruction	Control register + instruction	Control register + instruction	Control register + instruction
Canceling method other than resets	Interrupt	Interrupt *1	Interrupt *2	Interrupt *3
State after cancellation *4	Program execution state (interrupt processing)	Program execution state (interrupt processing)	Program execution state (interrupt processing)	Program execution state (reset processing)
Main Clock Oscillator	Operation possible	Operation possible	Operation possible ^{*5}	Operation possible ^{*5}
Sub-Clock Oscillator	Operation possible	Operation possible	Operation possible ^{*6}	Operation possible ^{*6}
High Speed On- Chip Oscillator	Operation possible	Operation possible	Stopped	Stopped
Low Speed On- Chip Oscillator	Operation possible	Operation possible	Stopped	Stopped
IWDT-dedicated On-Chip Oscillator	Operation possible*7	Operation possible ^{*7}	Operation possible ^{*7}	Stopped (undefined) ^{*7}
PLL	Operation possible	Operation possible	Stopped	Stopped
CPU	Stopped (retained)	Stopped (retained)	Stopped (retained)	Stopped (undefined)
On-chip RAM 1 (0001 0000h to 0001 FFFFh)	Operation possible (retained)	Stopped (retained)	Stopped (retained)	Stopped (undefined)
On-chip RAM 0 (0000 0000h to 0000 FFFFh)	Operation possible (retained)	Stopped (retained)	Stopped (retained)	Stopped (retained/ undefined) ^{*8}
Flash Memory	Operating	Stopped (retained)	Stopped (retained)	Stopped (retained)
USB 2.0 Host/Function	Operating possible	Stopped (retained) ^{*9}	Stopped (retained)	Stopped (retained/ undefined) *10
Watchdog timer (WDT)	Stopped (retained)	Stopped (retained)	Stopped (retained)	Stopped (undefined)
Independent Watchdog Timer (IWDT)	Operation possible ^{*7}	Operation possible ^{*7}	Operation possible ^{*7}	Stopped (undefined) ⁻⁷
Realtime clock (RTC)	Operation possible	Operation possible	Operation possible	Operation possible
8-bit timer (unit 0, unit 1) (TMR)	Operation possible	Operation possible ^{*11}	Stopped (retained)	Stopped (undefined)
Voltage detection circuit (LVD)	Operation possible	Operation possible	Operation possible	Operation possible ^{*12*13}
Power-on reset circuit	Operating	Operating	Operating	Operating ^{*13}
Peripheral modules	Operation possible	Stopped(Retained)	Stopped(Retained)	Stopped (undefined)
I/O pin state	Operating	Retained *14	Retained *15	Retained *15
	1.2 in the hardware manu	al for additional informa	tion relevant to this table	

Note : Refer to table 11.2 in the hardware manual for additional information relevant to this table.



14. External buses

Some members of the RX family include external bus controllers and SDRAM controllers.

14.1 Endian of External Memory Areas

Memory accesses for devices connected to external buses may be configured by software for big endian or little endian access. The access mode is set on a per-chip-select basis by setting the EMODE bit in the chip select control register (CSiCR) or the SDC mode register (SDCMOD). Note that the EMODE bit changes the access **relative to** the MCU's main operating mode which is specified in the MDEB and MDES registers. Instruction code can only be allocated in an external memory area when its endian matches that of the MCU (EMODE = 0). See the table below for example configurations.

MDE	CPU Endian	EMODE	Access to external devices	Can MCU run instruction code from this area?
7	Little endian	0	Little endian	Yes
0	Big Endian	1	Little endian	No
0	Big Endian	0	Big endian	Yes
7	Little Endian	1	Big endian	No

14.2 Bus Width & Multiplexing

The access width of external memory areas can be set to 8-bit, 16-bit, or 32-bit. Width settings are set on a per-chipselect basis by setting the BSIZE bits in the CSiCR register or the SDC Control Register (SDCCR). The address and data lines of chip-select regions can be multiplexed by setting the MPXEN bit in the CSiCR register. Note that if MPXEN bit is set (data and address lines are multiplexed) then 32-bit access width should not be chosen since operation cannot be guaranteed.

14.3 Drive Strength for Bus Signals

When using an external memory area, pins that control the bus signals should be set for high-drive capacity output. See Section 10.1.3 for more information on setting the drive capacity of a pin.

14.4 Bus Errors

Two types of bus errors can be detected: illegal address accesses and bus access timeouts. Illegal address errors are detected for external areas that are disabled, and for reserved areas. Reference Section **Error! Reference source not found.** for locations of reserved areas. Timeout errors are detected when bus accesses do not complete in 768 cycles.

When a bus error occurs the bus error interrupt (BURERR) will be generated. The code below shows the enabling of the bus error interrupt.



RX63N, RX631 Group

```
/* Enable the bus error interrupt to catch accesses to illegal/reserved areas of
  memory and bus access timeouts. The ISR for this interrupt can be found below
  in the function "bus_error_isr" */
/* Clear any pending interrupts */
IR(BSC,BUSERR) = 0;
/* Make this the highest priority interrupt (adjust as necessary for your
  application). */
IPR(BSC,BUSERR) = 0x0F;
/* Enable the interrupt in the ICU*/
IEN(BSC,BUSERR) = 1;
/* Enable illegal address interrupt in the BSC */
BSC.BEREN.BIT.IGAEN = 1;
/* Enable timeout detection interrupt in the BSC */
BSC.BEREN.BIT.TOEN = 1;
```

The code below shows an example of a bus error interrupt handler.

```
* Function name: bus error isr
 Description : This interrupt will fire if the user tries to access code or
              data from one of the reserved areas in the memory map,
              including the areas covered by disabled chip selects. This
              interrupt will also fire if a bus timeout is detected. A nop()
              statement is included here as a convenient place to set a
              breakpoint during debugging and development, and further
              handling should be added by the user for their application.
* Arguments
           : none
* Return value : none
#pragma interrupt (bus error isr(vect=VECT(BSC,BUSERR)))
void bus error isr (void)
{
   /* Clear the bus error */
   BSC.BERCLR.BIT.STSCLR = 1;
   /* To find the address that was accessed when the bus error occurred, read
     the register BSC.BERSR2.WORD. The upper 13 bits of this register contain
      the upper 13-bits of the offending address (in 512K byte units). */
   /* nop() for convenience of setting a breakpoint. */
   nop();
}
```



15. References

The following documents were used in creating this Quick Design Guide:

Reference	Document Number	Description
1	R01UH0041EJ0160_RX63N631	RX63N Group, RX631 Group User Manual: Hardware
2	R20UT0398EJ0300_E1E20	E1 Emulator E20 Emulator User's Manual
3	R20UT0399EJ0600_E1E20_RX	E1/E20 Emulator Additional Document for User's Manual (RX User System Design)
4	R01AN0252ET0101_RX	RX Family Debug Console Function Using E1
5	R01AN0287EU0300_RX	RX600 & RX200 Series The Flash Loader Project
6	R01AN0544EU0240	RX600 & RX200 Series Simple Flash API for RX
7	R01AN1245EJ0100	RX63N Group, RX631 Group Initial Setting



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Revision Record

		Description			
Rev.	Date	Page	Summary		
1.00	Apr.10.2013		First edition issued		
1.10	July.4.2013	9	Added setup for big-endian mode		
			Described initial states of system clocks after reset		
		11	Added section 5.5		
		12	Added reference to Low CL Sub-Clock app note		
		18	Added details about enabling external bus and disabling on- chip ROM		
		27	Added section 10.7		
1.11	Feb.3.2014	7	Corrected typo in table 2 (PC7 column)		
		8	"Independent Watchdog Timer" was incorrectly called "Internal Watchdog Timer"		

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

 The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access
 these addresses; the correct operation of LSI is not guaranteed if they are accessed.
- 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal.
 Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

— The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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